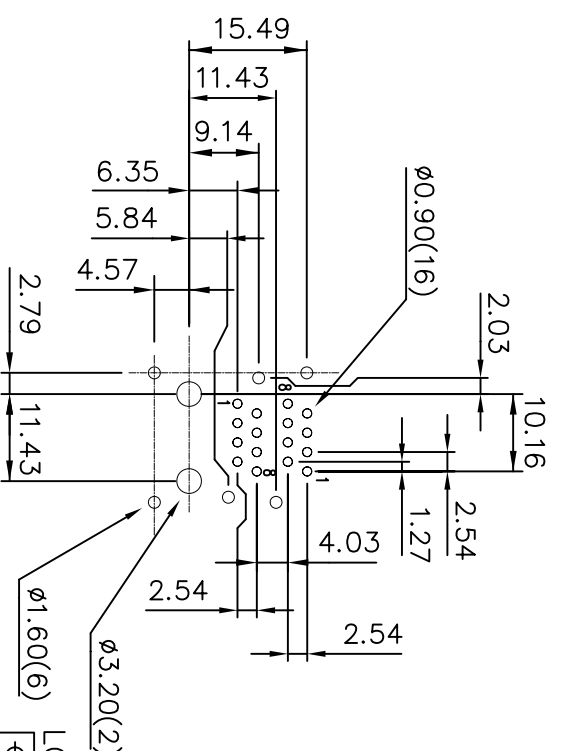
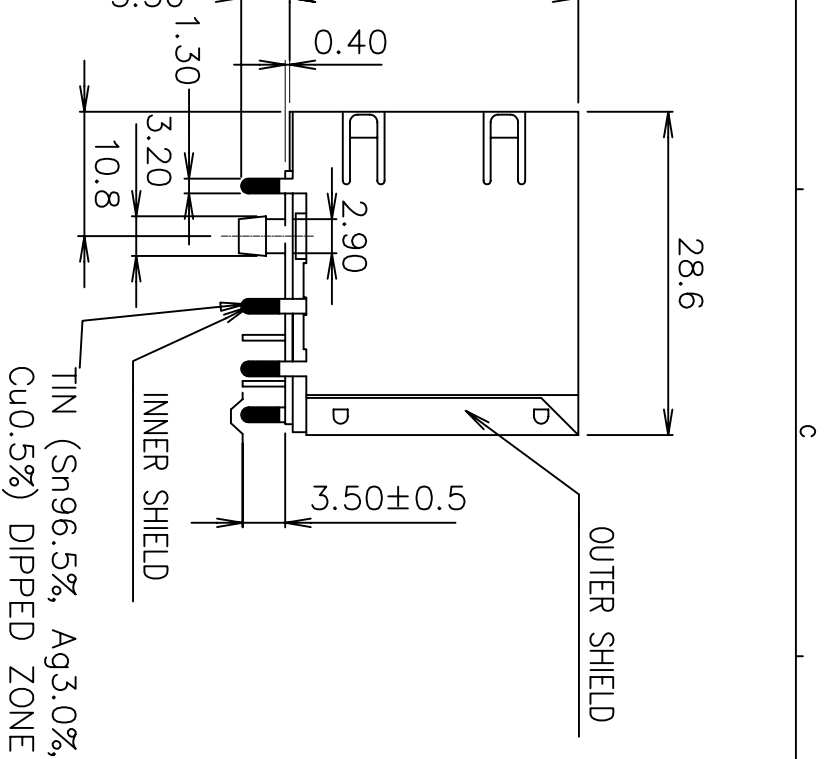




**THE DATASHEET OF
PK8071305122201S RMH2**

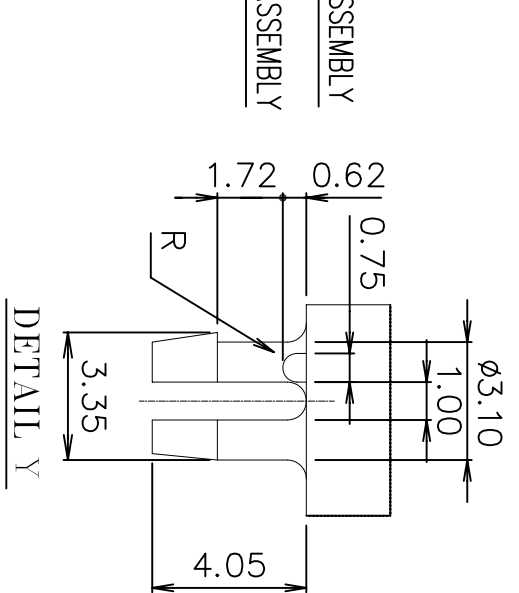


REVISIONS			
SYM ZONE	ECN, ERN NO.	DATE	APPRD.
A	PROPOSAL	AUG10/06	L.CHAN
B	ADD TIN DIPPED	SEP06/06	L.CHAN
C	CHANGE UNIT	SEP08/06	L.CHAN



RECOMMENDED P.C.B. LAYOUT
(COMPONENT SIDE OF BOARD)

LOCATE HOLES
 $\phi 0.13$
HOLES DIMENSIONS ARE BASIC



MATERIALS:
CONTACTS: PHOSPHOR BRONZE, SELECTIVELY PLATED
REFER TO P/N FOR GOLD THICKNESS ON MATING AREAS.
50 MICRO" MIN. NICKEL OVERALL.
GOLD FLASH ON CONTACT TAILS.

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
COLOUR - BLACK, FLAMMABILITY RATING UL 94V-0
SHIELD: COPPER ALLOY WITH NICKEL PLATED AND TIN (Sn96.5%, Ag3.0%, Cu0.5%)
DIPPED PCB TAILS

RECOMMENDED SOLDERING TEMPERATURE:
WAVE SOLDERING OR REFLOW SOLDERING AT 260°C MAXIMUM
FOR 5 SEC MAXIMUM

HIGH TEMPERATURE MATERIAL

8 8 - 1 X 1 0 H
PLATING
5 μ " GOLD
15 μ " GOLD
30 μ " GOLD
50 μ " GOLD

FOR PURPOSE AND SUCH INFORMATION
FOR MANUFACTURING
AMPHENOL CANADA CORP.

DRAWN	P/WANG	DATE
DESIGNED		AUG10/06
CHECKED	CH/GOW	AUG10/06
I. E. APPRD.		
Q. A. APPRD.		
DWG. APPRD.		
ENG. REL. NO.		
REF.		
DIMENSIONS ARE IN CODE ID. NO. 03554		
SCALE		

TITLE	
Stackable Modular Jack	
2X1 PORT, SHIELD, 8 POS., 8 CONTACTS, - ROHS COMPLIANT	

DWG. NO.	DRAWING NO.	REV.
	P-RJE11-188-1X10-H	C

4

3

2

1

C

D

E

F

1

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 [Intel Information](#)

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-  Alternative Solution
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